15 ~ 60mA Single/Dual channel LED Driver

Features

- The most easy used linear constant current LED driver
- 15mA~ 60mA, 1 to 2 channel constant current regulator
- No external current setting resistor is needed
- 1.5V ~ 12V wide supply voltage range supports self power structure in lighting application
- Very low dropout voltage
  $I_{PN} \leqq 40mA \rightarrow V_{PN} \fallingdotseq 0.4V$
  $I_{PN} > 40mA \rightarrow V_{PN} \fallingdotseq 0.6V$
- PWM dimming by VDD pin
- 2uS/2uS current rising/falling time
- -40℃ ~ 120℃ junction operating temperature
- Cascade-able for higher voltage applications* (type 1Axx only)
- Current leak/no leak design for lighting/display Application
- Low chip to chip current skew
  $I_{PN} \leqq 40mA \rightarrow$ chip current skew < ±5%
  $I_{PN} > 40mA \rightarrow$ chip current skew < ±6%
- Less than 1%/V load (or line) regulation
- Minimized footprint
- Green package

* Patent pending

Product Description

MT501 is a simple general purpose current regulation component that can be easily used in various LED lighting applications. With the excellent load/line regulation and minimized chip current skew, MT501 keep LED's current very stable even when power or load fluctuate in a wide range and make light intensity very uniform in large area of LED light source.

Except power supply function, the VDD pin of MT501 is output enable (OE) also, and can be used in digital PWM controlled circuit to achieve more precise current adjusting in gray level applications.

The minimized power supply voltage let MT501 be used as a current regulative diode (CRD) when VDD and VP pin are tight together. This application makes MT501 very easy to be used. Just like a diode, when this diode is inserted in LED series, the current in circuit is regulated.

In high supply voltage and low LED load voltage applications, two or more single channel MT501 (A type) can be connected in series to share redundant high voltage. With the unique share voltage technology of MOS-TECH Semiconductor, the extra redundant voltage can be shared by each MT501 by a reasonable mechanism. This special capability let MT501 very suit for the usage of wide range power supply that many liner type LED drivers cannot work.

Applications

Type A – For lighting application

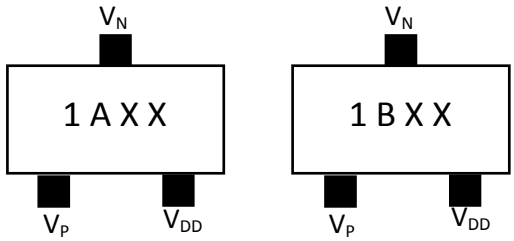
- General LED lighting
- LCD back lighting
- LED torch / flashlight
- RGB lighting

Type B – For display application (No current leak)

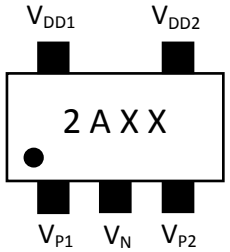
- RGB display pixel driver

Package Type

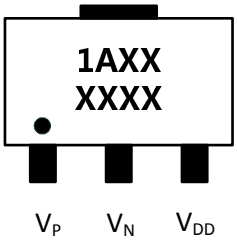
- SOT 23-3 (single channel, type A/B)



- SOT23-5 (dual channel, type A) – two independent driver in single package.



- SOT89-3 (single channel, type A, package option)

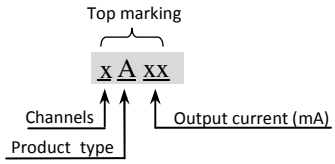


Terminal Description

Pin Name	Function
V_{DD}	Power supply
V_P	Current in
V_N	Current out

Ordering Information

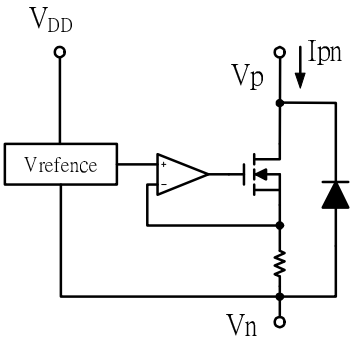
Part Number: MT501



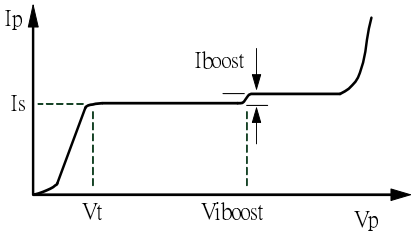
Example: "1A25" is single channel cascade-able MT501, current 25mA.
"1B25" is single channel NU501, current 25mA
"2A20" is dual channel NU501, current 20mA.

PS: Before you issue your P.O., please contact your agent or MOS-TECH Semiconductor to make sure the channel and center current that is available.

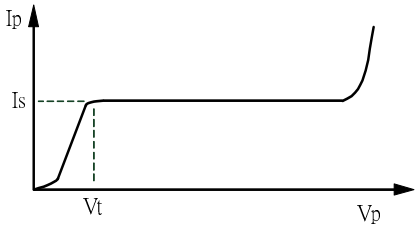
Block Diagram per channel and Ideal IV characteristic



Type A – IV curve



Type B – IV curve



Maximum Ratings (T = 25°C)

Characteristic	Symbol		Rating	Unit
Supply voltage	V_{DD}		0 ~ 16	V
Output voltage	V_P		-0.2 ~ 17	V
Output current	I_{PN}		I_S** +10%	mA
Power Dissipation (Ta=25°C)	PD	SOT 23	0.25	W
		SOT 89	0.7	
Thermal Resistance (On PCB, Ta=25°C)	$R_{TH(j-a)}$	SOT 23	300	°C /W
		SOT 89	180	
Operating temperature	T_{OPR}		-40~+85	°C
Storage temperature	T_{STG}		-55~+150	°C

Electrical Characteristics and Recommended Operating Conditions

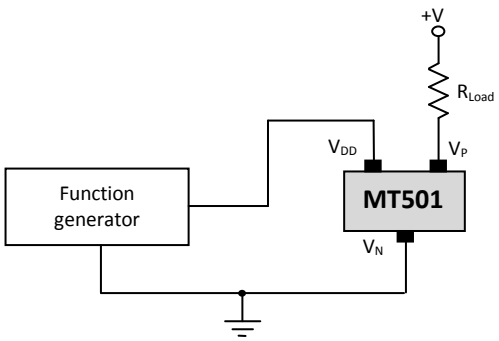
Characteristic	Symbol	Condition		Min.	Typ.	Max.	Unit
Supply voltage	V_{DD}	Room Temp. V_{PN} >= 1V	I_S <= 25mA	1.5	-	12	V
			I_S <= 40mA	2	-	12	
			I_S > 40mA	2.5	-	12	
Supply current	I_{DD}	-		100	150	250	uA
Minimum dropout voltage	V_{PNmin}	V_{DD} >=3.8V		0.4	-	0.6	V
Maximum output voltage	V_{PNmax}	$I_{PN} = I_S$		-	-	0.25 / I_{PN}	V
Output breakdown voltage	V_{PNBD}	I_{PN} = 0, V_{DD} = 0V		-	-	17	V
Output current	I_S	Spec.		15	-	60	mA
Leakage	$I_{Leakage}$	0V < V_{DD} < 0.4V, V_P = 10V	Type A	1	-	5	uA
			Type B	0	-	0.5	uA
Line regulation	%/V_{DD}	12V > V_{DD} > 1.6V		-	-	±1	%/V
Load regulation	%/V_P	8V > V_P > 1.6V		-	-	±1	%/V
Thermal regulation	%/10℃	V_{DD} = V_P = 2V		-	-	±0.5	%/10℃
Threshold voltage (Type A only)	V_{iboost}	$I_P = I_S$*1.1		11	12	13	V
Current boost (Type A only)	I_{boost}	$V_P = V_{iboost}$		7	10	13	% * I_S
Chip current skew	I_{Skew}	V_{DD} = V_P = 2V	I_{PN} <= 40mA	-	-	5	%
			I_{PN} > 40mA	-	-	6	

** I_S is output saturation current.

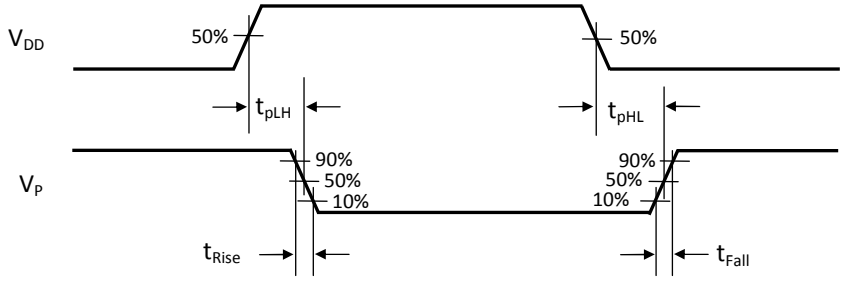
Switching Characteristics (T = 25℃)

Characteristic	Symbol	Condition	Min.	Typ.	Max.	Unit
Propagation Delay Time V_{DD} from "L" to "H"	t_{pLH}	V_P=1V, V_{DD} = 0V → 3V	-	1	-	uS
Output current rising time	t_{Rise}	V_P=1V, V_{DD} = 0V → 3V	-	1.5	5	uS
Propagation Delay Time V_{DD} from "H" to "L"	t_{pHL}	V_P=1V, V_{DD} = 3V → 0V	-	1	-	uS
Output current falling time	t_{Fall}	V_P=1V, V_{DD} = 3V → 0V	-	1.5	5	uS

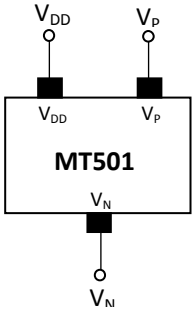
Test Circuit

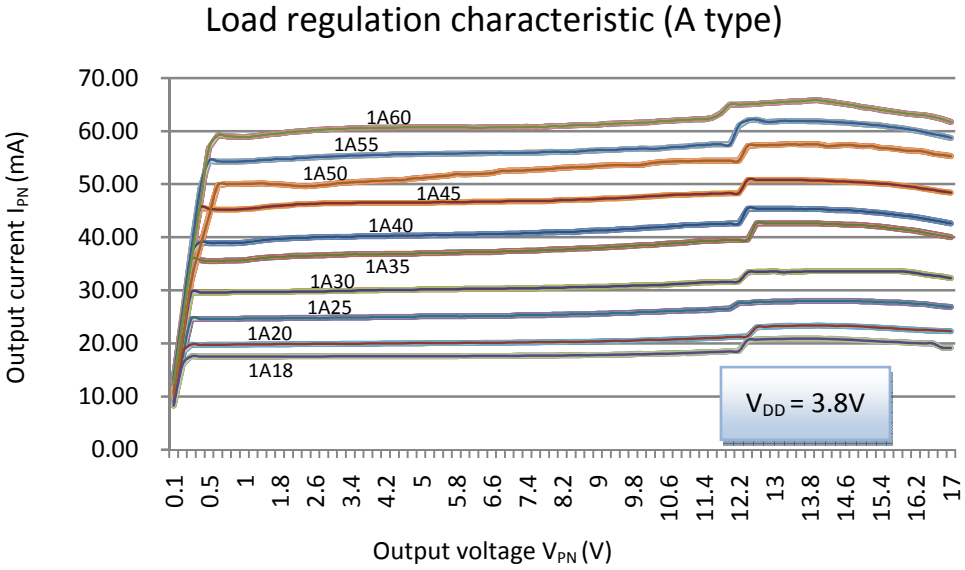


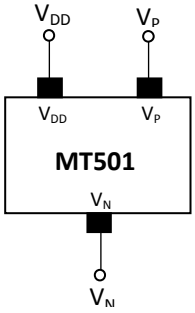
Timing Waveform

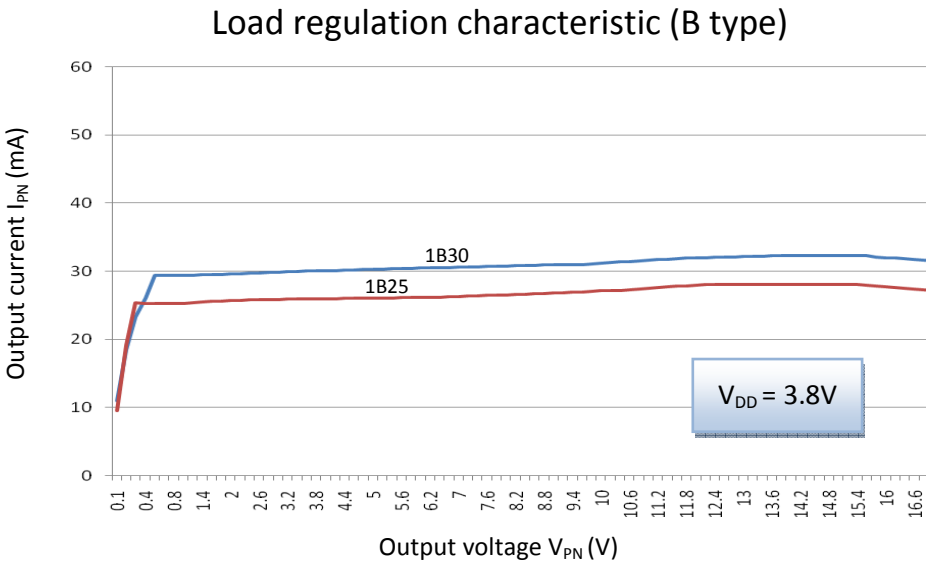


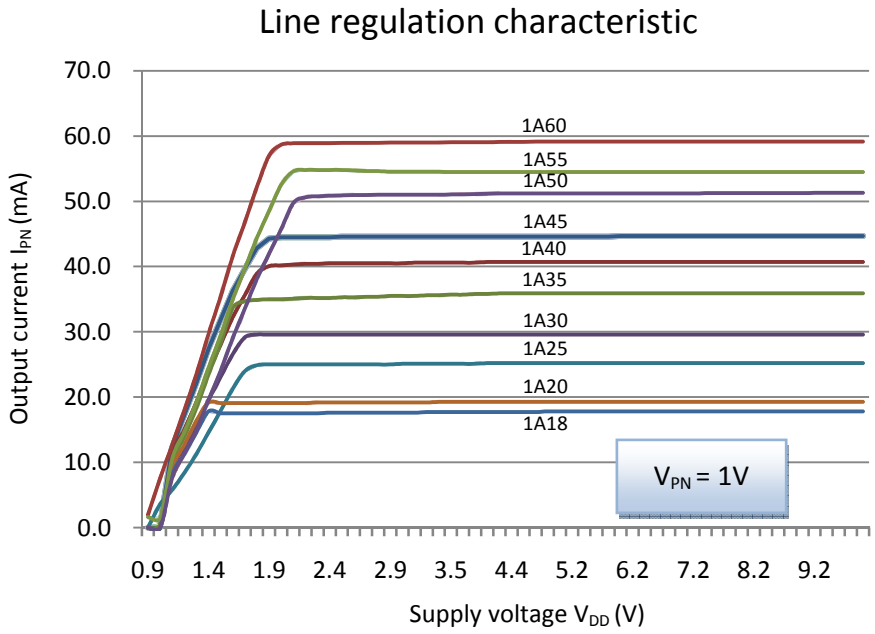
I/V curve

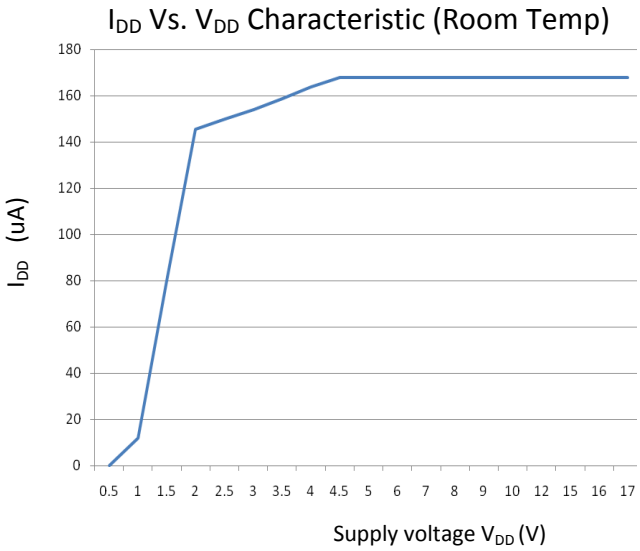


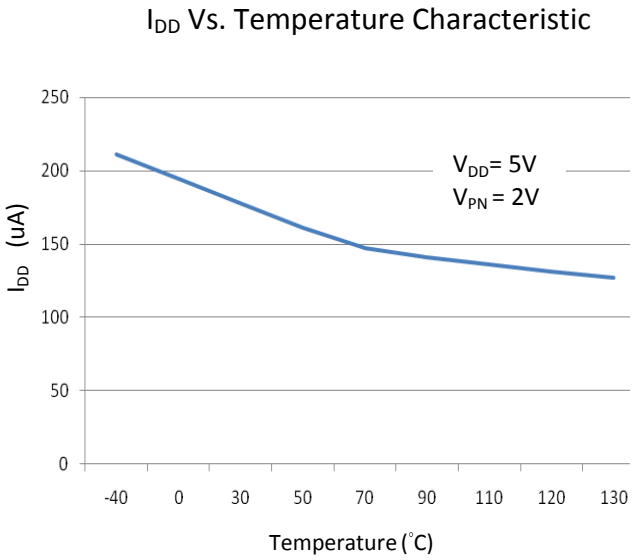












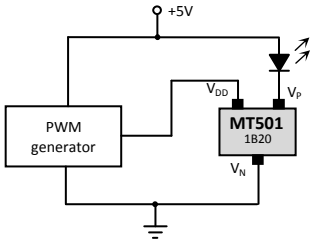
Application design consideration

MT501 is a linear constant current driver. While this device is designed in lighting system, the heat generation should be considered. Generally, the higher current designed in system, the higher power will suffer by this power consuming by MT501 and to increase the whole system efficiency, the drop voltage across minimized. The following design note can reduce the heat generation from output constant current and the needed supply voltage (normal operation condition).

1. Drop the power supply voltage as low as possible in the normal operation condition.
2. Get the LEDs in current loop as many as possible in the normal operation condition.
3. Get a voltage sharing resistor in series in current loop .
4. If system power is greater that 24V, it suggests to connect a small SMD type capacitor (0.1uF~10uF) between VDD and VN pin. That will greatly improve the stability of system.

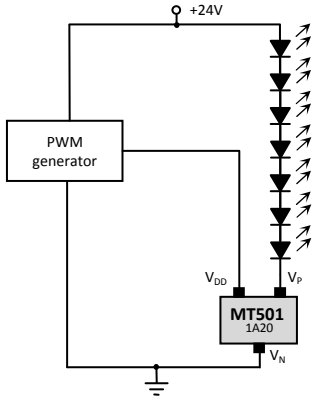
Application Circuits

- 5V PWM indicator application

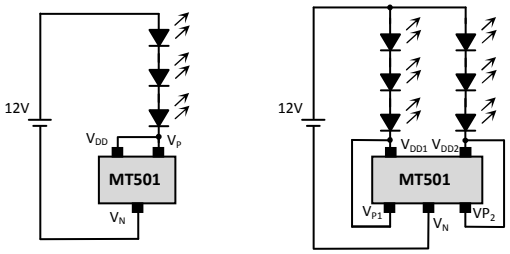


- 24V PWM lighting with dimming application

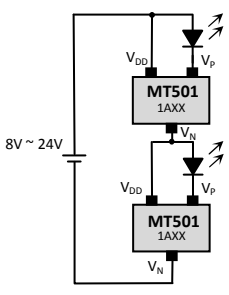
With the special designed character of leak, the A type NU501 can be used in dimming application even when system power is higher than the maximum V_P voltage.



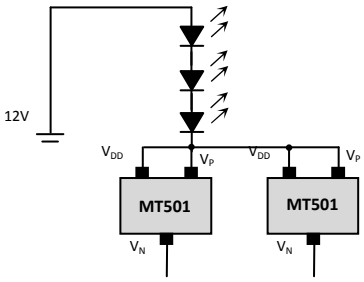
- 12V lighting application



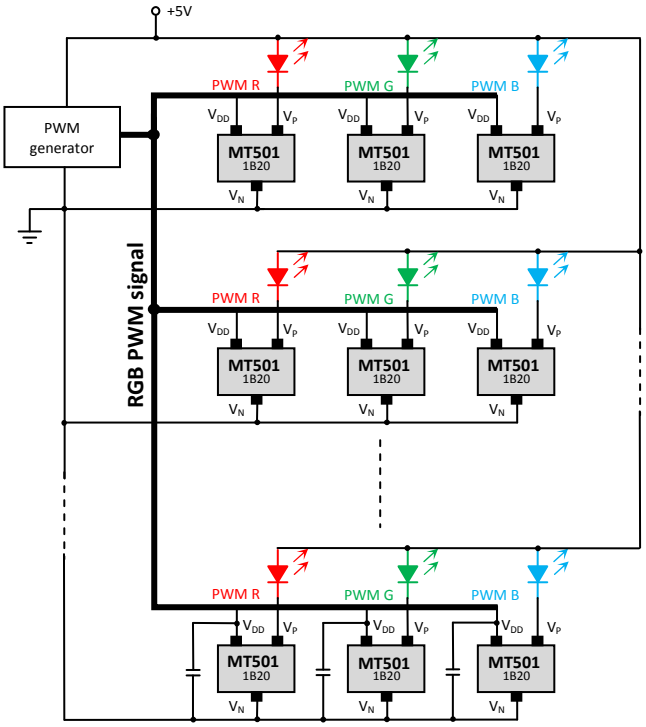
- High voltage drop application



- Parallel application



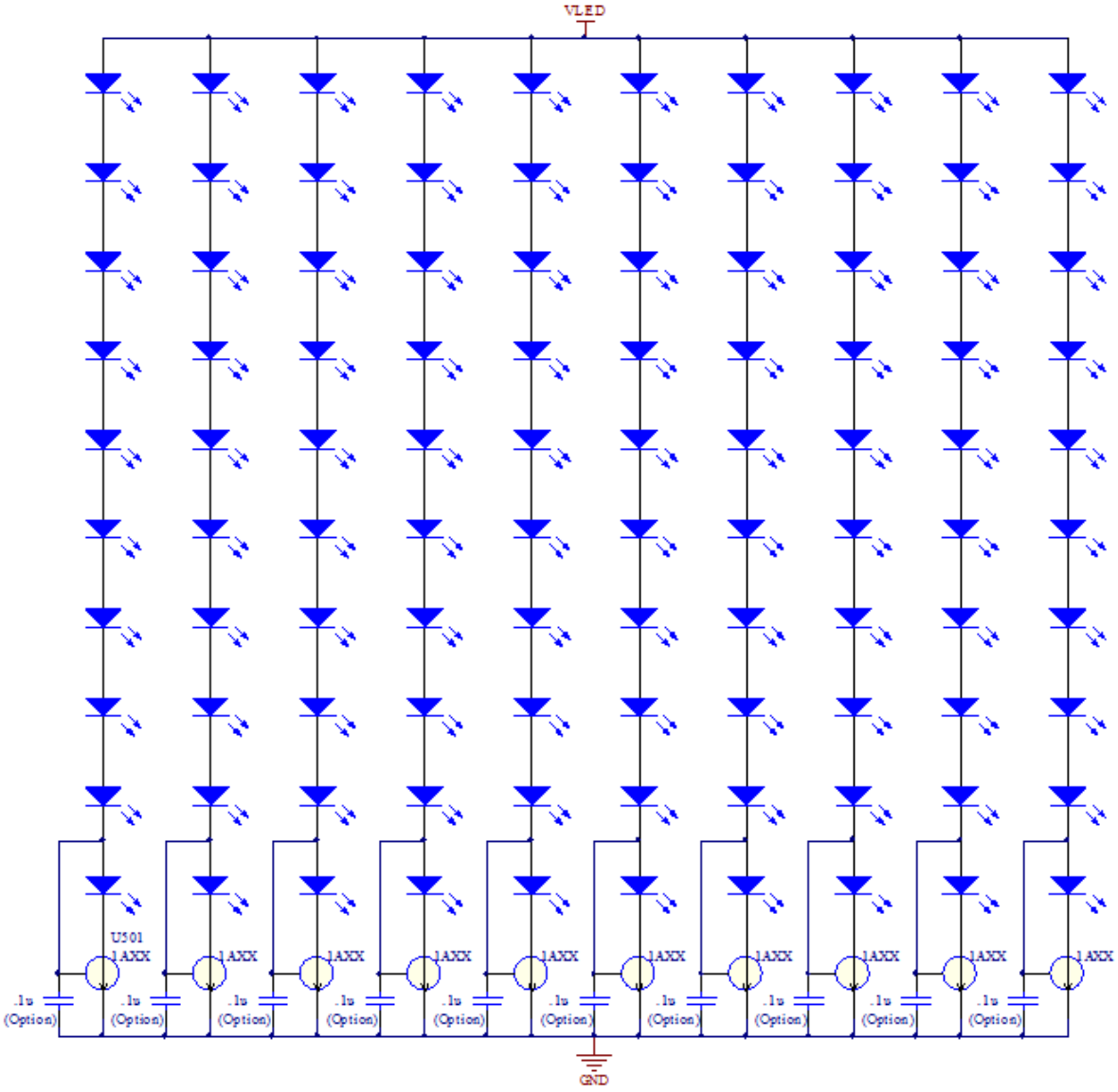
- RGB display pixel application



- 36V light tube application

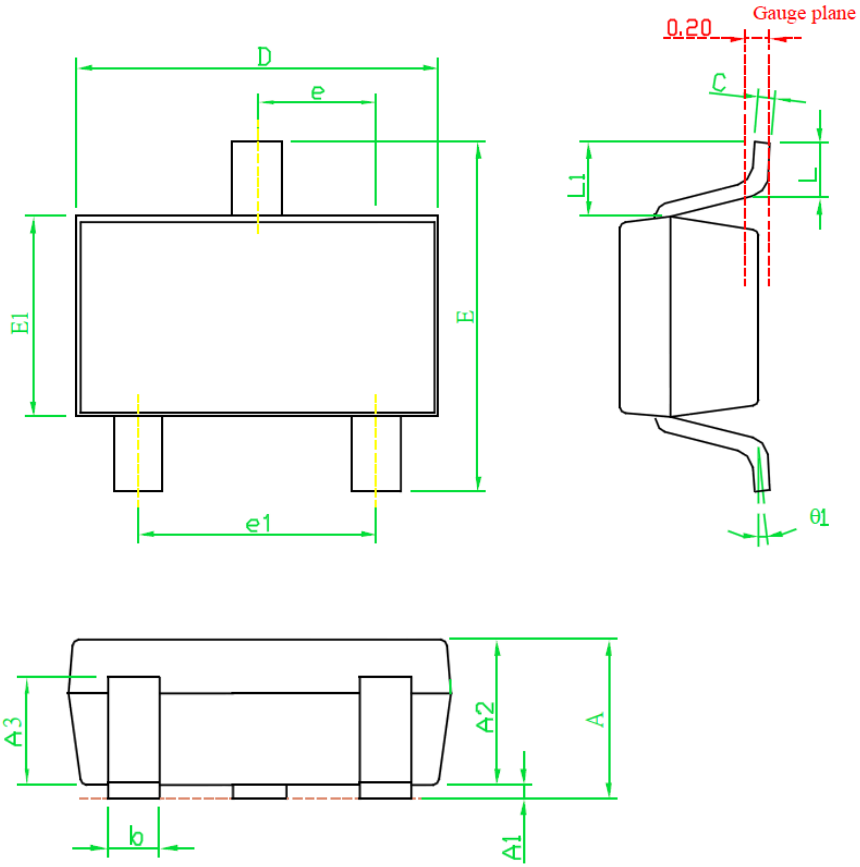
LED Vf = 3.3V ~ 3.5V

V_{LED} = 35.5V ~ 40V

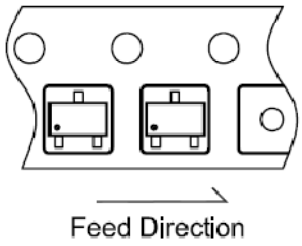


Package Dimensions

- SOT23-3



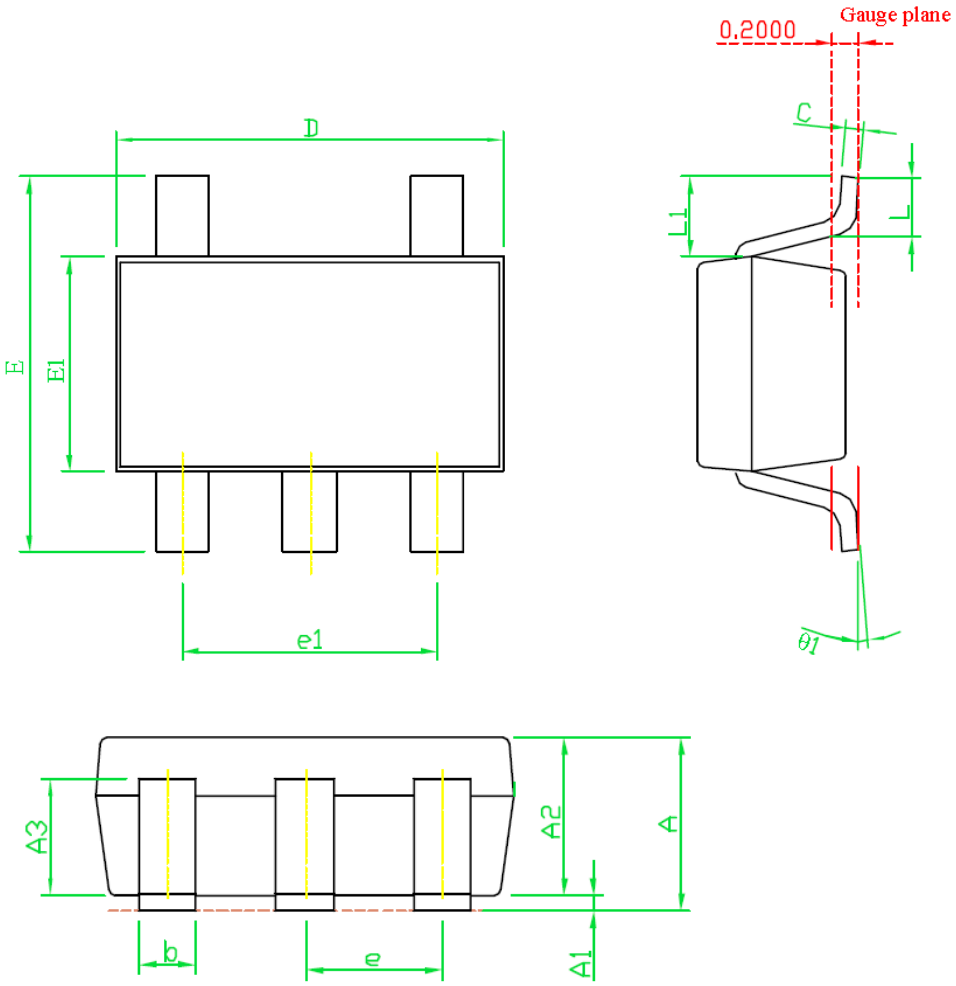
SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	1.00	1.10	1.40
A1	0.00	---	0.10
A2	1.00	1.10	1.30
A3	0.70	0.80	0.90
b	0.35	0.40	0.50
C	0.10	0.15	0.25
D	2.70	2.90	3.10
E1	1.40	1.60	1.80
e	---	0.95(TYP)	---
e1	---	1.90(TYP)	---
E	2.60	2.80	3.00
L	0.37	---	---
θ1	1°	5°	9°
L1	0.5	0.6	0.7



Taping Specification

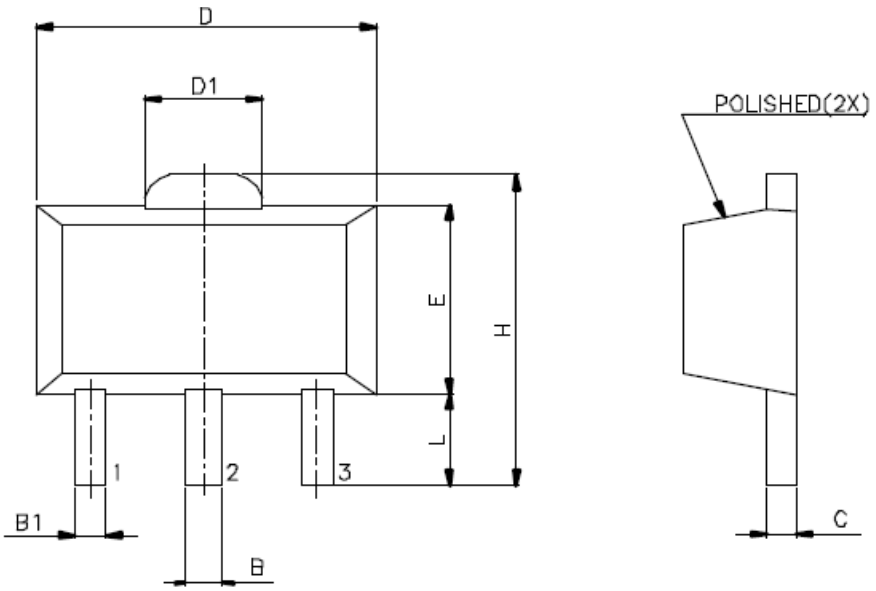
PACKAGE	Q'TY/REEL
SOT23-3	3,000 ea
SOT23-5	3,000 ea
SOP89	1,000 ea

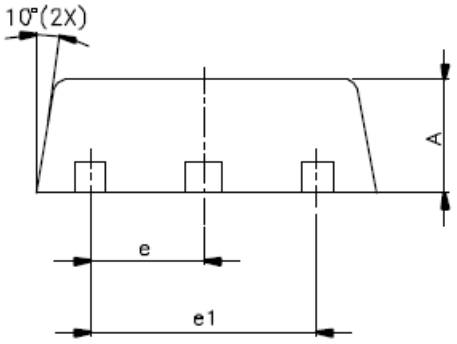
- SOT23-5

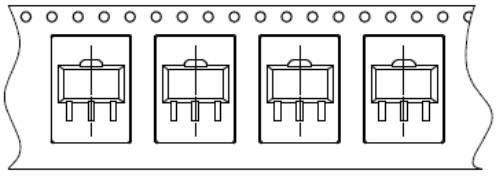


SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	1.00	1.10	1.40
A1	0.00	---	0.10
A2	1.00	1.10	1.30
A3	0.70	0.80	0.90
b	0.35	0.40	0.50
C	0.10	0.15	0.25
D	2.70	2.90	3.10
E1	1.50	1.60	1.80
e1	---	1.90(TYP)	---
E	2.60	2.80	3.00
L	0.37	---	---
θ1	1°	5°	9°
e	---	0.95(TYP)	---
L1	0.5	0.6	0.7

- SOT89







SOT – 89

SYMBOLS	MIN.	MAX.
A	1.40	1.60
B	0.44	0.56
B1	0.36	0.48
C	0.35	0.44
D	4.40	4.60
D1	1.35	1.83
E	2.29	2.60
H	3.94	4.25
e	1.50 BSC	
e1	3.00 BSC	
L	0.89	1.2

UNIT : mm

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Keep safety first in your circuit designs!

1. MOS-TECH Semiconductor Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.
   Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

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